JVI / XI //I Dual, Rail-to-Rail, High-Output-Drive Op Amp in UCSP

General Description

The MAX4369 dual, high-output-drive op amp combines single-supply operation with high-output-current drive, Rail-to-Rail[®] outputs in an ultra chip-scale package (UCSPTM). The device is unity-gain stable to 3.5MHz and operates from a single 2.3V to 5.5V supply. The MAX4369 is guaranteed to source and sink up to 87mA with a 5V supply.

The MAX4369 is capable of delivering 120mW of continuous average power to a 16 Ω load, or 75mW to a 32 Ω load with 1% total harmonic distortion plus noise (THD + N), making the device ideal for portable audio applications.

The MAX4369 is specified over the extended temperature range (-40°C to +85°C) and is available in a tiny (1.5mm x 1.5mm) 9-bump UCSP.

_Applications

Cellular PhonesPDAsHeadphonesDC Motor ControlHeadsetsGeneral-Purpose Audio

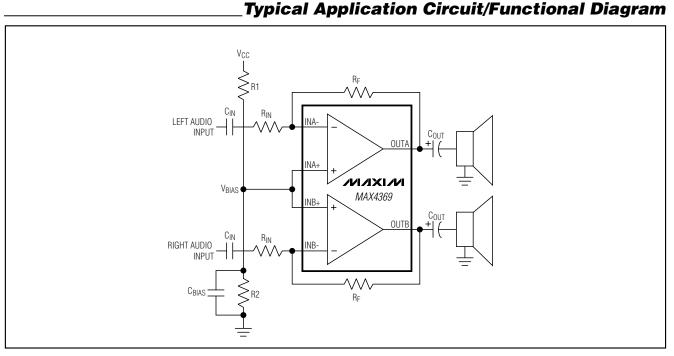
Features

- Tiny UCSP (1.5mm x 1.5mm)
- Drives 120mW into 16Ω
- 0.03% THD + N at 1kHz
- ♦ 2.3V to 5.5V Single-Supply Operation
- ImA Supply Current Per Amplifier
- Very High Power-Supply Rejection Ratio (96dB)
- Unity-Gain Stable
- Rail-to-Rail Output Stage
- Thermal Overload and Short-Circuit Protection

Ordering Information

PART	TEMP RANGE	BUMP- PACKAGE	TOP MARK
MAX4369EBL-T	-40°C to +85°C	9 UCSP-9	AAN

Bump Configuration appears at end of data sheet.



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_ Maxim Integrated Products 1

For pricing, delivery, and ordering information, please contact Maxim/Dallas Direct! at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

Dual, High-Output-Drive, UCSP, Rail-to-Rail Output Op Amp

ABSOLUTE MAXIMUM RATINGS

 V_{CC} to GND.....-0.3V to +6V All Other Pins to GND.....-0.3V to (V_{CC} + 0.3V) Output Short Circuit to V_{CC} or GND (Note 1).....Continuous Continuous Power Dissipation (T_A = +70°C)

9-Bump USCP (derate 4.7mW/°C above +70°C).......379mW Operating Temperature Range-40°C to +85°C

Junction Temperature	+150°C
Storage Temperature Range	
Bump Temperature (soldering) (Note 2)	
Infrared (15s)	+220°C
Vapor Phase (60s)	

Note 1: Continuous power dissipation must also be observed.

Note 2: This device is constructed using a unique set of packaging techniques that impose a limit on the thermal profile that the device can be exposed to during board-level solder attach and rework. This limit permits only the use of the solder profiles recommended in the industry standard specification, JEDEC 020A, paragraph 7.6, Table 3 for IR/VPR and convection reflow. Preheating is required. Hand or wave soldering is not allowed.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(V_{CC} = 5V, V_{CM} = 0, V_{OUT} = V_{CC}/2, $R_L = \infty$ connected to V_{CC}/2, $T_A = T_{MIN}$ to T_{MAX} , unless otherwise noted. Typical values are at $T_A = +25^{\circ}$ C.) (Note 3)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS	
Supply Voltage Range	V _{CC}	Inferred from PSRR test		2.3		5.5	V	
Supply Current Per Amplifier	ICC					1	2.2	mA
Input Offset Voltage	Vos					±0.35	±5	mV
Open-Loop Voltage Gain	Av	$0.6V \le V_{OUT} \le V_{CC} - 0.6V$		$R_L = 10k\Omega$		88		dB
		0.00 ≤ 0001 ≤ 00	<u>-</u> 0.6V	$R_L = 32\Omega$	80 84	84		uв
Input Bias Current	Ι _Β					0.2	3	μA
Input Offset Current	los					0.01	0.3	μA
Input Common-Mode Range	VCM	Inferred from CMRR test		0		V _{CC} - 1.0	V	
Differential Input Resistance	RIN(DIFF)	$V_{IN+} - V_{IN-} = \pm 10 \text{mV}$			500		kΩ	
Power-Supply Rejection Ratio	PSRR	$2.3V \le V_{CC} \le 5.5V$		80	96		dB	
Common-Mode Rejection Ratio	CMRR	$0 \le V_{CM} \le V_{CC} - 1.0V$		70	80		dB	
Output Course (Sink Current	lour	$2.7V \le V_{CC} \le 5.5V$, $0.6V \le V_{OUT} \le V_{CC} - 0.6V$		±87	±125		mA	
Output Source/Sink Current	lout	$2.3V \le V_{CC} \le 2.7V, 0.6V \le V_{OUT} \le V_{CC} - 0.6V$			±115			
Output Voltage Swing	Vout	2.7V ≤ V _{CC} ≤ 5.5V	$R_L = 10k\Omega$	V _{CC} - V _{OH}		300		mV
				VOL		15		
			$R_L = 32\Omega$	V _{CC} - V _{OH}		330	600	
				Vol		180	600	
			$R_L = 16\Omega$	VCC - VOH		350		
				Vol		310		
Output Power	Pout	THD + N = 1%, f = 1kHz (Note 4)	$R_{L} = 16\Omega$ $R_{L} = 32\Omega$			120		mW
					56	75		
Total Harmonic Distortion Plus	s THD + N	$f = 1 \text{kHz} \text{ (Note 5)} \frac{P_{OUT} = 100 \text{mW}, \text{ R}_{L} = 16 \Omega}{P_{OUT} = 65 \text{mW}, \text{ R}_{L} = 32 \Omega}$		mW, $R_L = 16\Omega$		0.05		%
Noise					0.03		,0	
Unity-Gain Bandwidth	BW					3.5		MHz
Gain-Bandwidth Product	GBWP					3.5		MHz

ELECTRICAL CHARACTERISTICS (continued)

(V_{CC} = 5V, V_{CM} = 0, V_{OUT} = V_{CC}/2, R_L = ∞ connected to V_{CC}/2, T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at $T_A = +25^{\circ}C.)$ (Note 3)

PARAMETER	SYMBOL	CONDITIONS	MIN TYP MAX	UNITS
Full-Power Bandwidth	FPBW		25	kHz
Phase Margin	PM		73	degrees
Gain Margin	GM		27	dB
Crosstalk			90	dB
Signal-to-Noise Ratio	SNR	$V_{OUT} = 1.5V_{RMS}, A_V = 1V/V (Note 5)$	100	dB
Slew Rate	SR		1	V/µs
Settling Time	ts	Settling to 0.1%	10	μs
Input Capacitance	CIN		1	pF
Input-Voltage Noise Density	en	f = 1kHz	40	nV/√Hz
Input-Current Noise Density	in	f = 1 kHz	1.5	pA/√Hz
Capacitive-Load Stability		$A_V = -1V/V$, no sustained oscillations	200	pF
Short-Circuit Current	100	To V _{CC}	185	mA
Short-Circuit Current	ISC	To GND	215	ША
Thermal Shutdown Threshold			165	°C
Thermal Shutdown Hysteresis			10	°C
Power-Up Time	tpu		25	μs

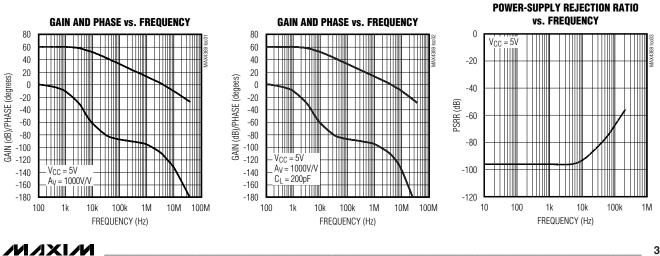
Note 3: All specifications are 100% tested at $T_A = +25$ °C; temperature limits are guaranteed by design.

Note 4: Guaranteed by design. Not production tested.

Note 5: Measurement bandwidth is 22Hz to 22kHz.

Typical Operating Characteristics

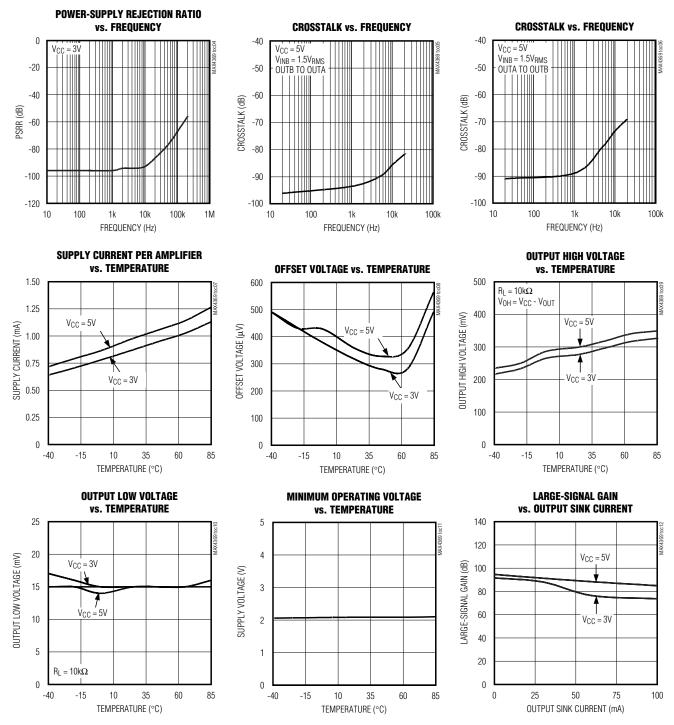
(THD + N measurement bandwidth = 22Hz to 22kHz, T_A = +25°C, unless otherwise noted.)



(THD + N measurement bandwidth = 22Hz to 22kHz, T_A = +25°C, unless otherwise noted.)

MAX4369

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Typical Operating Characteristics (continued)

Typical Operating Characteristics (continued)

(THD + N measurement bandwidth = 22Hz to 22kHz, $T_A = +25^{\circ}$ C, unless otherwise noted.)

100

140

40

30

LARGE-SIGNAL GAIN vs. OUTPUT SOURCE CURRENT 140 120 $V_{CC} = 5V$ $V_{CC} = 5V$ $V_{CC} = 3V$ 40 20 0

50

OUTPUT SOURCE CURRENT (mA)

TOTAL HARMONIC DISTORTION

PLUS NOISE vs. OUTPUT POWER

f_{IN} = 1kHz

80

OUTPUT POWER (mW)

TOTAL HARMONIC DISTORTION PLUS NOISE vs. OUTPUT POWER

f_{IN} = 1kHz

20

OUTPUT POWER (mW)

 $f_{IN} = 20Hz$

f_{IN} = 10kHz

10

100 120

75

 $f_{\text{IN}} = 20\text{Hz}$

0

100

10

1

0.1

0.01

100

10

1

0.1

0.01

0

THD + N (%)

0 20

V_{CC} = 3V

 $R_1 = 32\Omega$

THD + N (%)

25

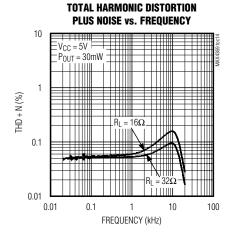
 $V_{CC} = 5V$

 $R_L = 16\Omega$

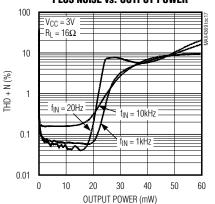
fιN

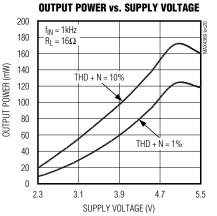
= 10kHz

40 60

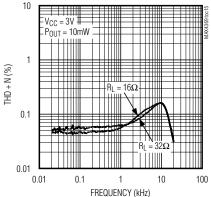


TOTAL HARMONIC DISTORTION PLUS NOISE vs. OUTPUT POWER

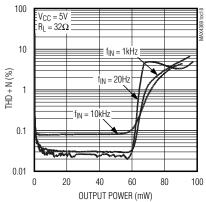




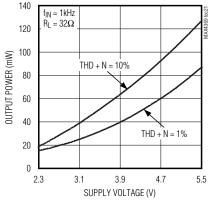




TOTAL HARMONIC DISTORTION PLUS NOISE vs. OUTPUT POWER

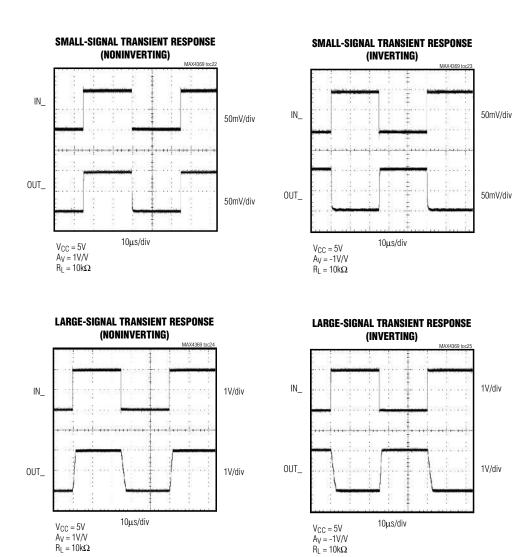


OUTPUT POWER vs. SUPPLY VOLTAGE



Typical Operating Characteristics (continued)

(THD + N measurement bandwidth = 22Hz to 22kHz, $T_A = +25^{\circ}$ C, unless otherwise noted.)



 $A_V = 1V/V$ $R_L = 10k\Omega$

NAME	FUNCTION
INA-	Amplifier A Inverting Input
OUTA	Amplifier A Output
INA+	Amplifier A Noninverting Input
GND	Ground
	Not Populated
V _{CC}	Power Supply
INB-	Amplifier B Inverting Input
OUTB	Amplifier B Output
INB+	Amplifier B Noninverting Input
	INA- OUTA INA+ GND — Vcc INB- OUTB

Bump Description

Detailed Description

Rail-to-Rail Output

The MAX4369 can drive a 10k Ω load and still swing within 300mV of the positive-supply rail, and 15mV of the negative-supply rail. Figure 1 shows the output voltage swing of the MAX4369 configured with A_V = 2V/V.

Driving Capacitive Loads

Driving a capacitive load can cause instability in many op amps. The MAX4369 is unity-gain stable for a range of capacitive loads to 200pF. Figure 2 shows the response of the MAX4369 with an excessive capacitive load. Adding a series resistor between the output and the output capacitor improves the circuit's response by isolating the load capacitance from the op amp's output.

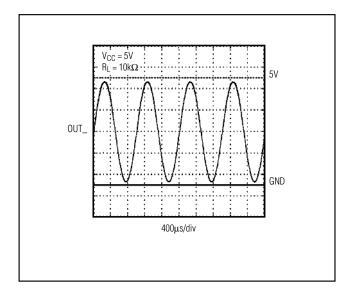


Figure 1. Rail-to-Rail Output Operation

Applications Information

Power Dissipation

Under normal operating conditions, linear power amplifiers like the MAX4369 can dissipate a significant amount of power. The maximum power dissipation of the UCSP package is given in the *Absolute Maximum Ratings* section under Continuous Power Dissipation or can be calculated by the following equation:

$$P_{DISS(MAX)} = \frac{T_{J(MAX)} - T_{A}}{\theta_{JA}}$$

where $T_{J(MAX)}$ is +150°C and θ_{JA} is the reciprocal of the derating factor in °C/W as specified in the *Absolute Maximum Ratings*. For example, θ_{JA} of a UCSP package is 211°C/W.

If the power dissipation exceeds the maximum allowed for a given package, either reduce V_{CC} , increase load impedance, decrease the ambient temperature or add heat sinking to the device. Large output, supply, and ground traces improve the maximum power dissipation in the package.

Thermal overload protection limits total power dissipation in the MAX4369. When the junction temperature exceeds $+165^{\circ}$ C, the thermal protection circuitry disables the amplifier output stage. The amplifiers are enabled once the junction temperature cools by 10°C. This results in a pulsing output under continuous thermal overload conditions.

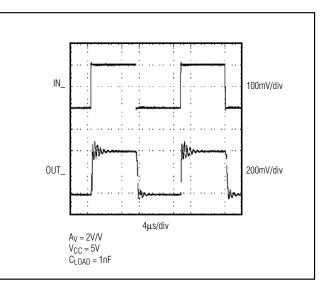


Figure 2. Small-Signal Transient Response with Excessive Capacitive Load

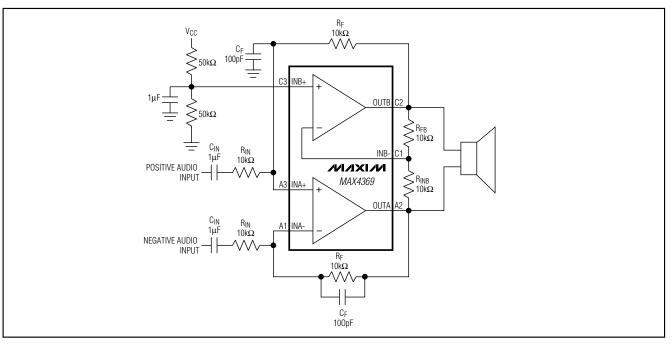


Figure 3. Differential Input/Differential Output Audio Amplifier

Supply Bypassing

Proper supply bypassing ensures low-noise, low-distortion performance. Place a 0.1μ F ceramic capacitor in parallel with a 10μ F capacitor from V_{CC} to GND. Locate the bypass capacitors as close to the device as possible.

Layout Considerations

Good layout improves performance by decreasing the amount of stray capacitance and noise at the amplifier's inputs and outputs. Decrease stray capacitance by minimizing PC board trace lengths, using surfacemount components and placing external components as close to the device as possible.

UCSP Considerations

For general UCSP information and PC layout considerations, please refer to the Maxim Application Note: *Wafer-Level Ultra-Chip-Scale Package*.

_Audio Applications

Single-Ended Stereo Amplifier

The high-output-current drive makes the MAX4369 ideal for use as a stereo audio amplifier (see *Typical Application Circuit/Functional Diagram*). In this configuration, the MAX4369 can deliver 120mW per channel into 16 Ω with less than 1% THD + N. The input capacitors (C_{IN}) block the DC component of the incoming

audio signal from the MAX4369. See the *Input Capacitor* section for selecting the value of C_{IN}. The output capacitors (C_{OUT}) serve to block the DC bias of the MAX4369 from the speaker load. See the *Output Capacitor* section for selecting the value of C_{OUT}. Set the DC bias (typically V_{CC}/2) by the resistive voltage-divider formed by R1 and R2. Ensure that the DC-bias level gives the incoming audio signal the maximum amount of headroom. C_{OUT} can be eliminated by operating the MAX4369 from a dual supply (±1.15V to ±2.5V) and setting the DC bias to 0.

Differential Input/Differential Output Audio Amplifier

The MAX4369 can be used as a differential input/differential output (BTL) amplifier (Figure 3). This configuration offers good CMRR, improved low-frequency PSRR, no large output-coupling capacitors compared to a single-ended amplifier. Resistors R_{INB} and R_{FB} configure the second amplifier as an inverting unity-gain follower. Connect the noninverting input of the second amplifier to a bias voltage, typically V_{CC}/2. Resistors R_{IN} and R_F set the differential gain of the device as follows:

$$\frac{V_{OUT(DIFF)}}{V_{IN(DIFF)}} = \frac{R_F}{R_{IN}}$$

Headphone Driver

MAX4369

The capacitors (CF) are necessary to maintain stability. The amplifier has two feedback paths, one from OUTA to INA- and the other from OUTB to INA+. At high frequencies, the second amplifier in the OUTB to INA+ feedback path introduces excessive phase shift. Compensate this phase shift by adding a capacitor from INA+ to GND. This suppresses the gain of the device at high frequencies, maintaining stability. Placing an identical-valued capacitor from INA- to OUTA improves overall performance.

Proper matching of the RF and RIN components is essential for optimum performance. A resistor pack offers a cost-effective solution for these matched components.

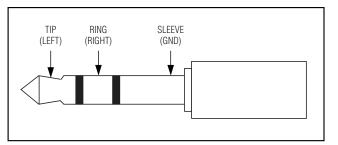


Figure 4. Typical 3-Wire Headphone Jack

The MAX4369 can drive a stereo headphone when configured as a single-ended stereo amplifier. Typical 3wire headphone plugs consist of a tip, ring, and sleeve. The tip and ring are the signal carriers while the sleeve is the ground connection (Figure 4). Figure 5 shows the MAX4369 configured to drive a set of headphones. OUTB is coupled to the ring and OUTA is coupled to the tip, delivering the signal to the headphone.

Capacitor Selection Input Capacitor

The input capacitor (C_{IN}), in conjunction with R_{IN}, forms a high-pass filter that removes the DC bias from an incoming signal (see the *Typical Application Circuit/ Functional Diagram*). The AC-coupling capacitor allows the amplifier to bias the signal to an optimum DC level. Assuming zero-source impedance, the -3dB point of the high-pass filter is given by:

$$f_{-3dB} = \frac{1}{2\pi R_{IN}C_{IN}}$$

Choose C_{IN} such that f_{-3dB} is well below the lowest frequency of interest. Setting f_{-3dB} too high affects the low-frequency response of the amplifier. Use capacitors whose dielectrics have low-voltage coefficients,

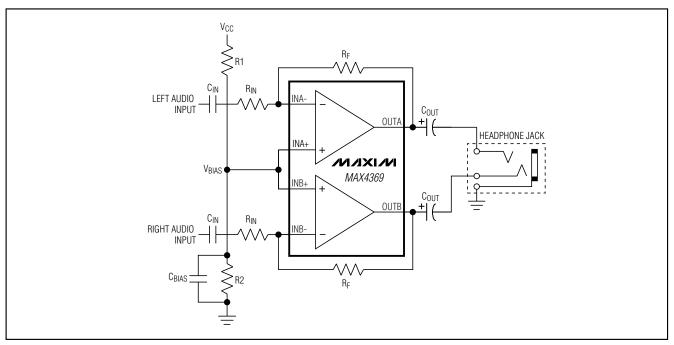


Figure 5. Stereo Headphone Driver



such as tantalum or aluminum electrolytic. Capacitors with high-voltage coefficients, such as certain ceramics, can result in an increase in distortion at low frequencies.

Other considerations when designing the input filter include the constraints of the overall system, the actual frequency band of interest and click-and-pop suppression. Although high-fidelity audio calls for a flat gain response between 20Hz and 20kHz, portable voicereproduction devices such as cellular phones and walkie-talkies need only concentrate on the frequency range of the spoken human voice (typically 300Hz to 3.5kHz). In addition, speakers used in portable devices typically have a poor response below 150Hz. Taking these two factors into consideration, the input filter might not need to be designed for a 20Hz to 20kHz response, saving both board space and cost due to the use of smaller capacitors.

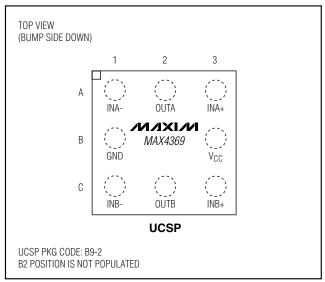
Output-Coupling Capacitor

The MAX4369 requires an output-coupling capacitor when configured as a single-ended amplifier. The output capacitor blocks the DC component of the amplifier output, preventing DC current flowing to the load. The output capacitor and the load impedance form a highpass filter with the -3dB point determined by:

$$f-3dB = \frac{1}{2\pi R_L C_{OUT}}$$

As with the input capacitor, choose COUT such that f-3dB is well below the lowest frequency of interest. Setting f-3dB too high affects the low-frequency response of the amplifier.

In addition to frequency band considerations, the load impedance is another concern when choosing COUT. Load impedance can vary, changing the -3dB point of the output filter. A lower impedance increases the corner frequency, degrading low-frequency response. Select COUT such that the worst-case load/COUT combination yields an adequate response.



Chip Information

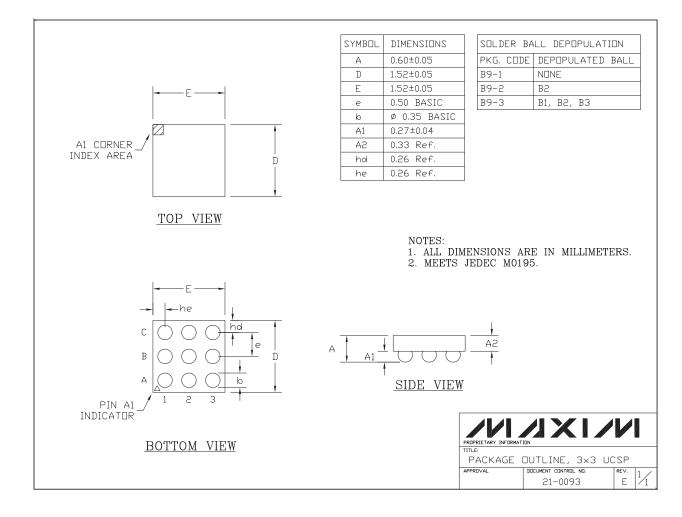
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MAX4369

Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to **www.maxim-ic.com/packages**.)



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